

General Description

The GreenMOS[®] high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS[®] Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity

GreenMOS[®]



Applications

- PC power
- LED lighting
- Telecom power
- Server power
- EV Charger
- Solar/UPS

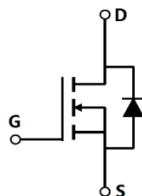
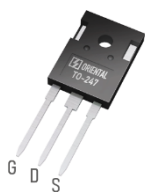
Key Performance Parameters

Parameter	Value	Unit
V_{DS}	800	V
I_D , pulse	54	A
$R_{DS(ON)}$, max @ $V_{GS}=10V$	200	m Ω
Q_g	54	nC
PD	231	W

Marking Information

Product Name	Package	Marking
OSG80R200HF-F	TO247	OSG80R200H

Package & Pin Information



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	800	V
Gate-source voltage	V_{GS}	± 30	V
Continuous drain current ¹⁾ , $T_C=25^\circ\text{C}$	I_D	18	A
Continuous drain current ¹⁾ , $T_C=100^\circ\text{C}$		11.4	
Pulsed drain current ²⁾ , $T_C=25^\circ\text{C}$	$I_{D, pulse}$	54	A
Continuous diode forward current ¹⁾ , $T_C=25^\circ\text{C}$	I_S	18	A
Diode pulsed current ²⁾ , $T_C=25^\circ\text{C}$	$I_{S, pulse}$	54	A
Power dissipation ³⁾ , $T_C=25^\circ\text{C}$	P_D	231	W
Single pulsed avalanche energy ⁴⁾	E_{AS}	640	mJ
MOSFET dv/dt ruggedness, $V_{DS}=0\dots 640\text{ V}$	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0\dots 640\text{ V}$, $I_{SD}\leq I_D$	dv/dt	15	V/ns
Operation and storage temperature	T_{stg}, T_j	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	$R_{\theta JC}$	0.54	$^\circ\text{C/W}$
Thermal resistance, junction-ambient	$R_{\theta JA}$	62	$^\circ\text{C/W}$

Electrical Characteristics at $T_j=25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	800			V	$V_{GS}=0\text{ V}$, $I_D=250\ \mu\text{A}$
Gate threshold voltage	$V_{GS(th)}$	2.9		3.9	V	$V_{DS}=V_{GS}$, $I_D=250\ \mu\text{A}$
Drain-source on-state resistance	$R_{DS(ON)}$		0.15	0.2	Ω	$V_{GS}=10\text{ V}$, $I_D=9\text{ A}$
			0.42			$V_{GS}=10\text{ V}$, $I_D=9\text{ A}$, $T_j=150^\circ\text{C}$
Gate-source leakage current	I_{GSS}			100	nA	$V_{GS}=30\text{ V}$
				-100		$V_{GS}=-30\text{ V}$
Drain-source leakage current	I_{DSS}			10	μA	$V_{DS}=800\text{ V}$, $V_{GS}=0\text{ V}$
Gate resistance	R_G		17.2		Ω	$f=1\text{ MHz}$, Open drain

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		2620		pF	$V_{GS}=0\text{ V}$, $V_{DS}=50\text{ V}$, $f=100\text{ kHz}$
Output capacitance	C_{oss}		111		pF	
Reverse transfer capacitance	C_{rss}		4.4		pF	
Turn-on delay time	$t_{d(on)}$		28		ns	$V_{GS}=10\text{ V}$, $V_{DS}=400\text{ V}$, $R_G=2\ \Omega$, $I_D=8\text{ A}$
Rise time	t_r		17		ns	
Turn-off delay time	$t_{d(off)}$		146		ns	
Fall time	t_f		18		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q_g		54		nC	$V_{GS}=10\text{ V}$, $V_{DS}=400\text{ V}$, $I_D=8\text{ A}$
Gate-source charge	Q_{gs}		11		nC	
Gate-drain charge	Q_{gd}		17		nC	
Gate plateau voltage	$V_{plateau}$		4.8		V	

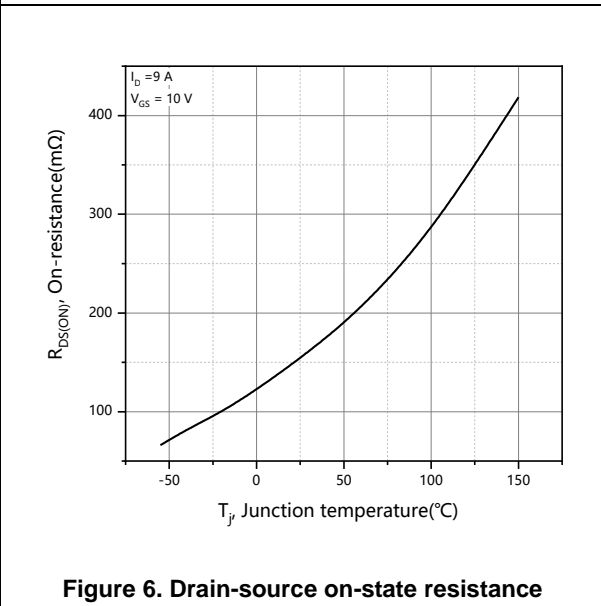
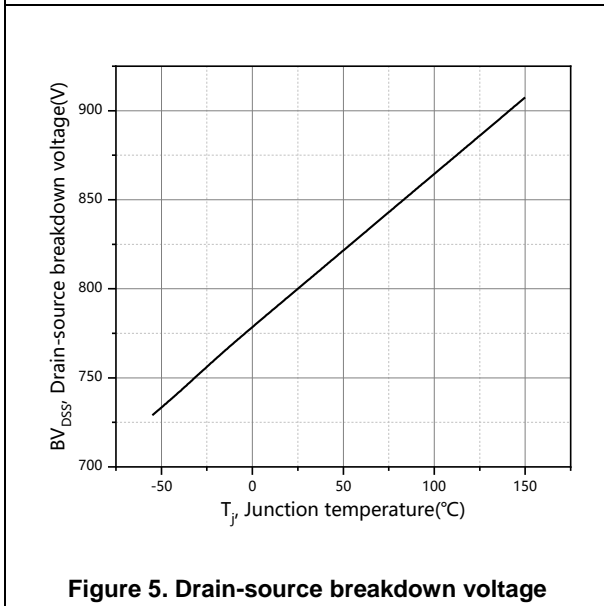
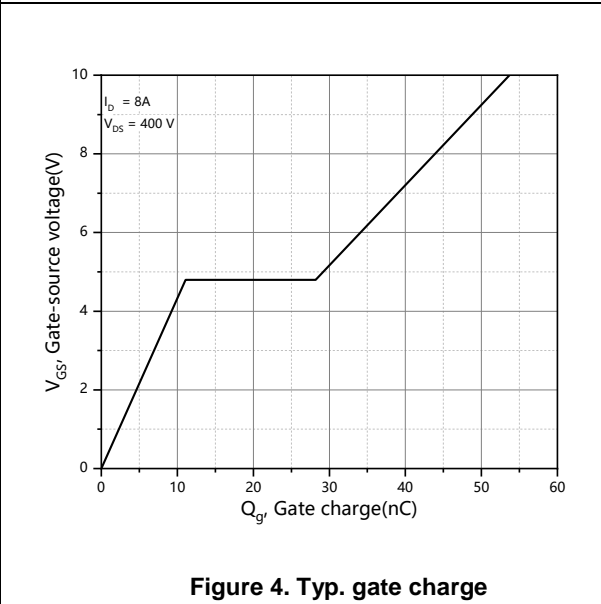
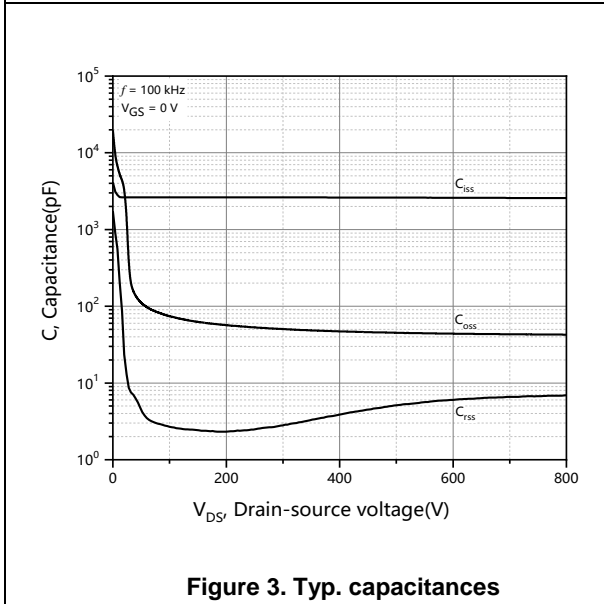
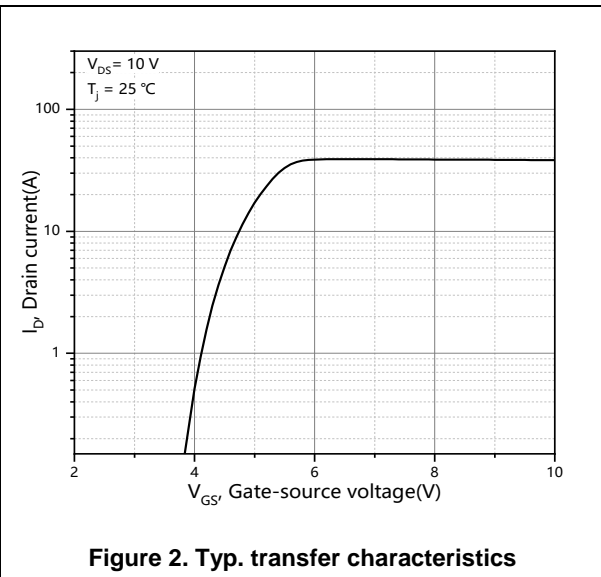
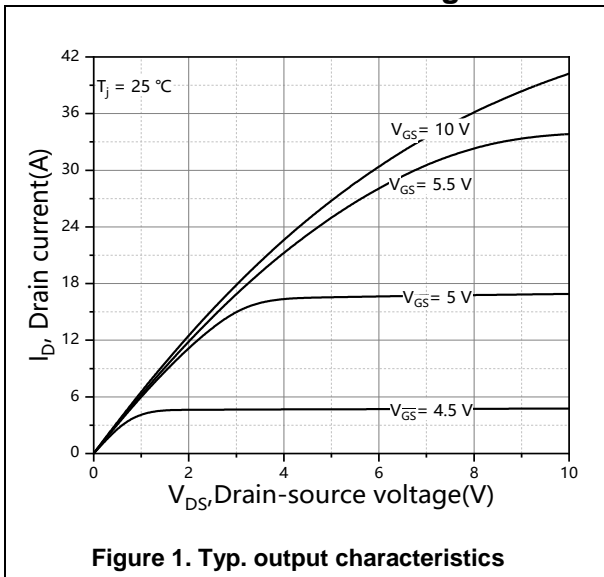
Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	V_{SD}			1.3	V	$I_S=18\text{ A}$, $V_{GS}=0\text{ V}$
Reverse recovery time	t_{rr}		342		ns	$V_R=400\text{ V}$, $I_S=8\text{ A}$, $di/dt=100\text{ A}/\mu\text{s}$
Reverse recovery charge	Q_{rr}		5		μC	
Peak reverse recovery current	I_{rrm}		29		A	

Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 4) $V_{DD}=50\text{ V}$, $V_{GS}=10\text{ V}$, $L=80\text{ mH}$, starting $T_j=25\text{ }^\circ\text{C}$.

Electrical Characteristics Diagrams



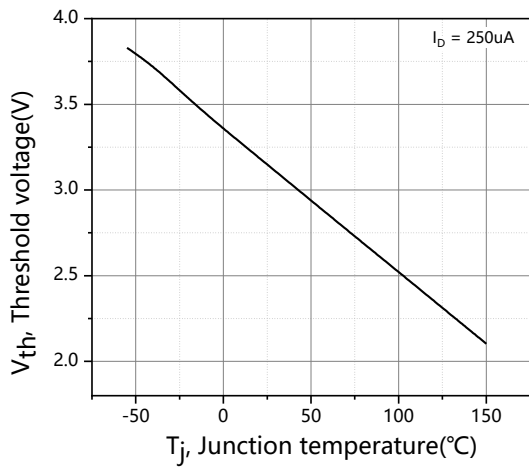


Figure 7. Threshold voltage

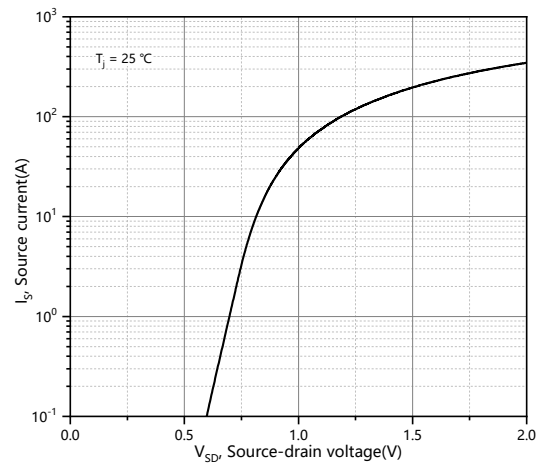


Figure 8. Forward characteristic of body diode

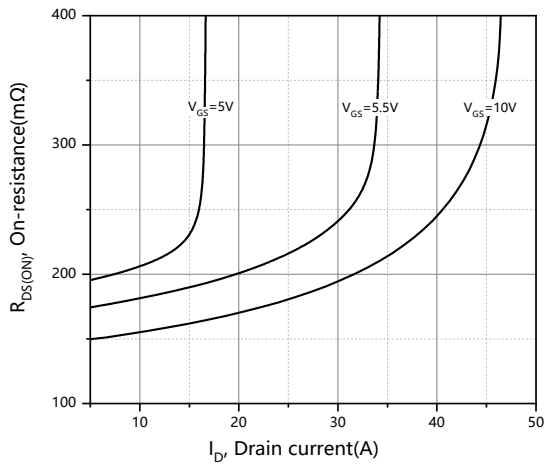


Figure 9. Drain-source on-state resistance

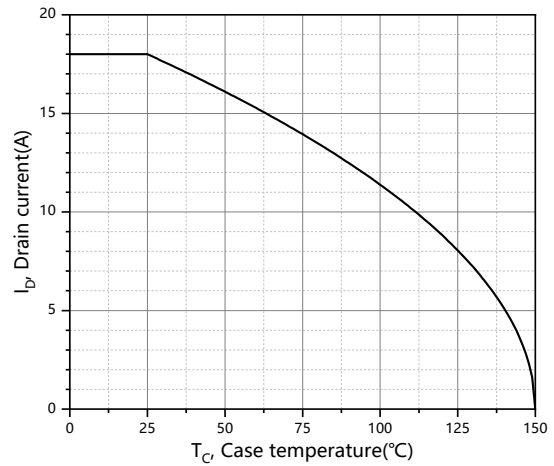


Figure 10. Drain current

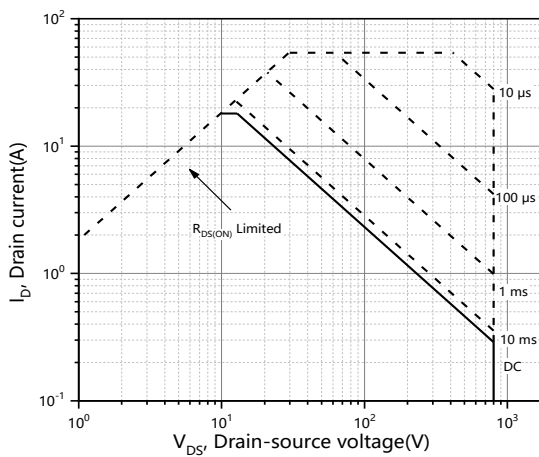


Figure 11. Safe operation area Tc=25 °C

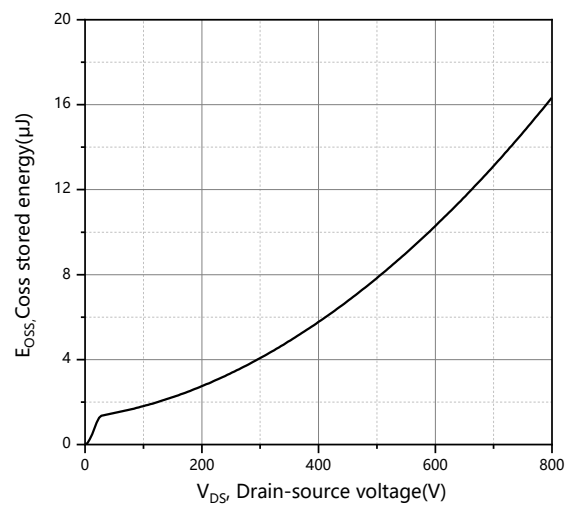
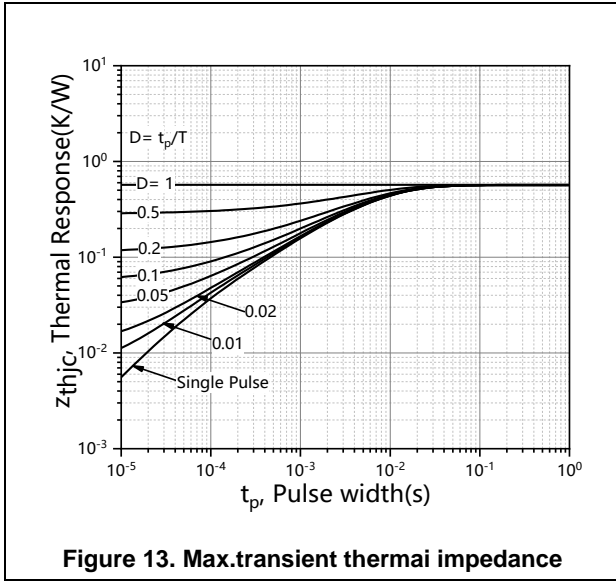


Figure 12. Typ. Coss stored energy



Test circuits and waveforms



Figure 1. Gate charge test circuit & waveform



Figure 2. Switching time test circuit & waveforms

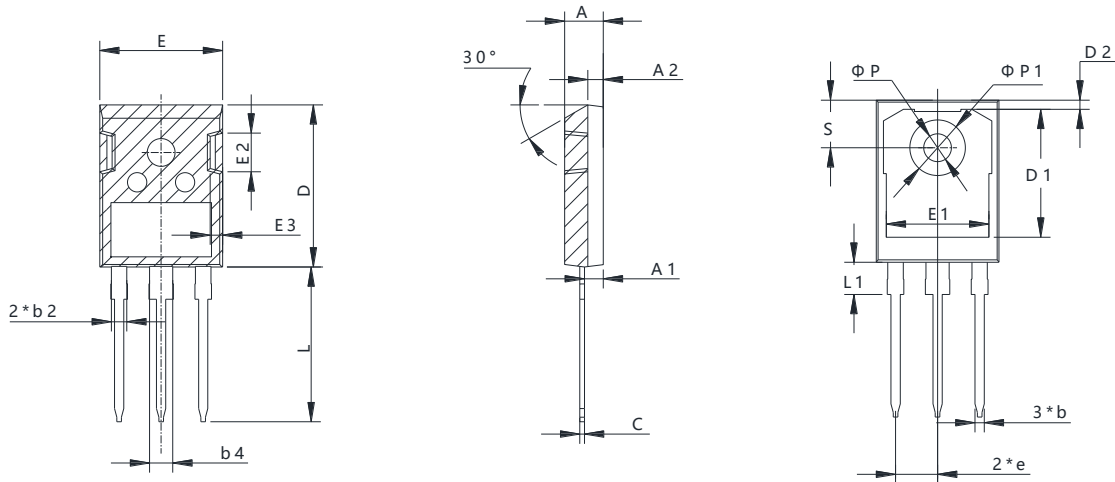


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms



Figure 4. Diode reverse recovery test circuit & waveforms

Package Information



mm			
Symbol	Min	Nom	Max
A	4.70	5.00	5.20
A1	2.30		2.50
A2	1.90	2.00	2.10
b	1.10	1.20	1.30
b2	\	2.00	\
b4	\	3.00	\
C	0.50	0.60	0.70
D	20.80	20.95	21.10
D1	16.25	16.55	16.85
D2	0.95	1.17	1.35
E	15.48	15.88	16.28
E1	13.20	13.50	13.80
E2	4.90	5.00	5.10
E3	1.50	1.60	1.70
e	5.34	5.44	5.54
L	19.80	20.00	20.32
L1	\	4.17	4.50
P	3.50	3.60	3.70
P1	7.00	7.19	7.40
S	6.04	6.15	6.30

Version 1: TO247-F package outline dimension

Ordering Information

Package Type	Units/ Tube	Tubes/ Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
TO247-F	30	10	300	6	1800

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG80R200HF-F	TO247	yes	yes	yes

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